

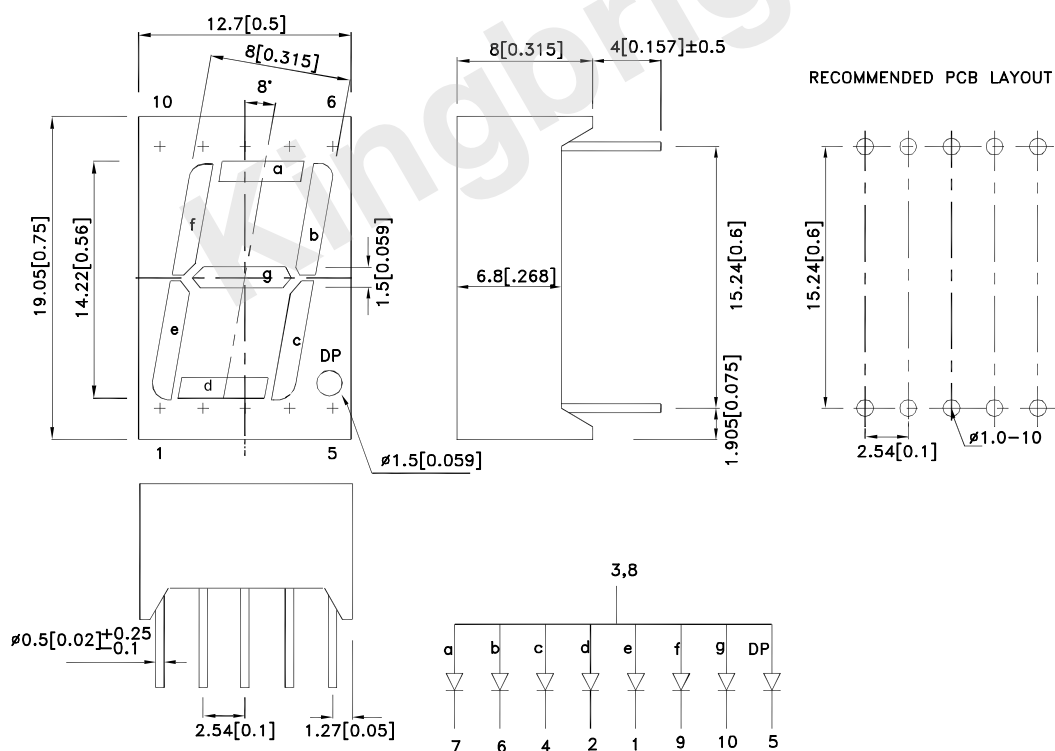
Features

- 0.56 inch digit height.
- Low current operation.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaN on GaAs substrate Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram



Selection Guide

| Part No. | Dice | Lens Type | Iv (ucd) [1] @ 10mA | | Description |
|---------------|---------------------|----------------|------------------------|--------|------------------------------------|
| | | | Min. | Typ. | |
| SA56-11SURKWA | Hyper Red (AlGaInP) | White Diffused | 31000 | 97000 | Common Anode, Rt. Hand Decimal. |
| | | | *14000 | *27000 | |

Note:

1. Luminous intensity/ luminous Flux: +/-15%.

*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Typ. | Max. | Units | Test Conditions |
|-----------------------|--------------------------|-----------|------|------|-------|---------------------------|
| λ_{peak} | Peak Wavelength | Hyper Red | 645 | | nm | I _F =20mA |
| λ_D [1] | Dominant Wavelength | Hyper Red | 630 | | nm | I _F =20mA |
| $\Delta\lambda_{1/2}$ | Spectral Line Half-width | Hyper Red | 28 | | nm | I _F =20mA |
| C | Capacitance | Hyper Red | 35 | | pF | V _F =0V;f=1MHz |
| V _F [2] | Forward Voltage | Hyper Red | 1.95 | 2.5 | V | I _F =20mA |
| I _R | Reverse Current | Hyper Red | | 10 | uA | V _R =5V |

Notes:

1.Wavelength: +/-1nm.

2.Forward Voltage: +/-0.1V.

3.Wavelength value is traceable to the CIE127-2007 compliant national standards.

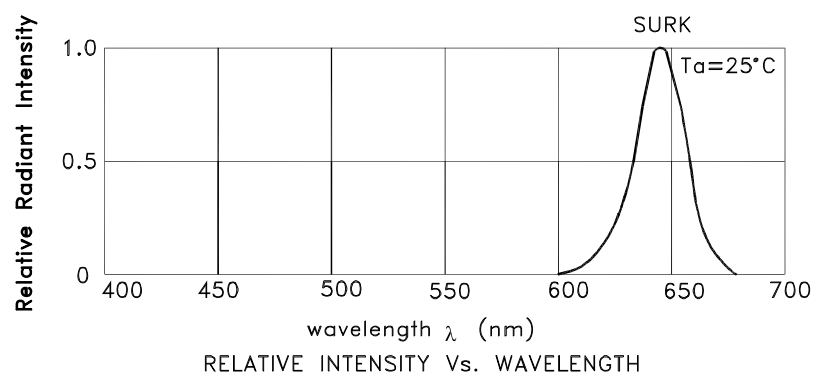
Absolute Maximum Ratings at TA=25°C

| Parameter | Hyper Red | Units |
|---------------------------------|-----------------------|-------|
| Power dissipation | 75 | mW |
| DC Forward Current | 30 | mA |
| Peak Forward Current [1] | 185 | mA |
| Reverse Voltage | 5 | V |
| Operating / Storage Temperature | -40°C To +85°C | |
| Lead Solder Temperature[2] | 260°C For 3-5 Seconds | |

Notes:

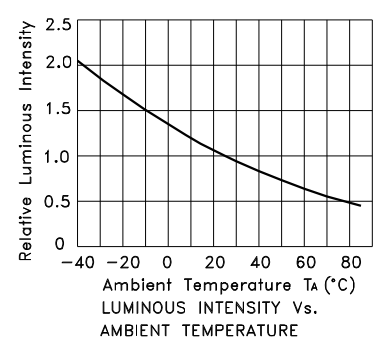
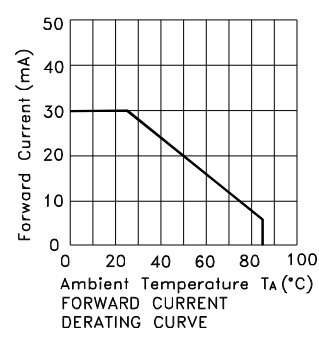
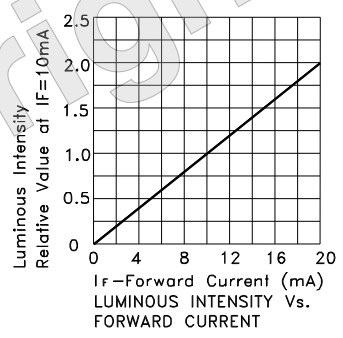
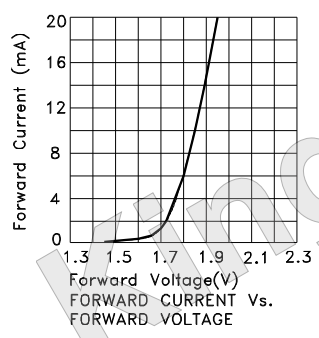
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.



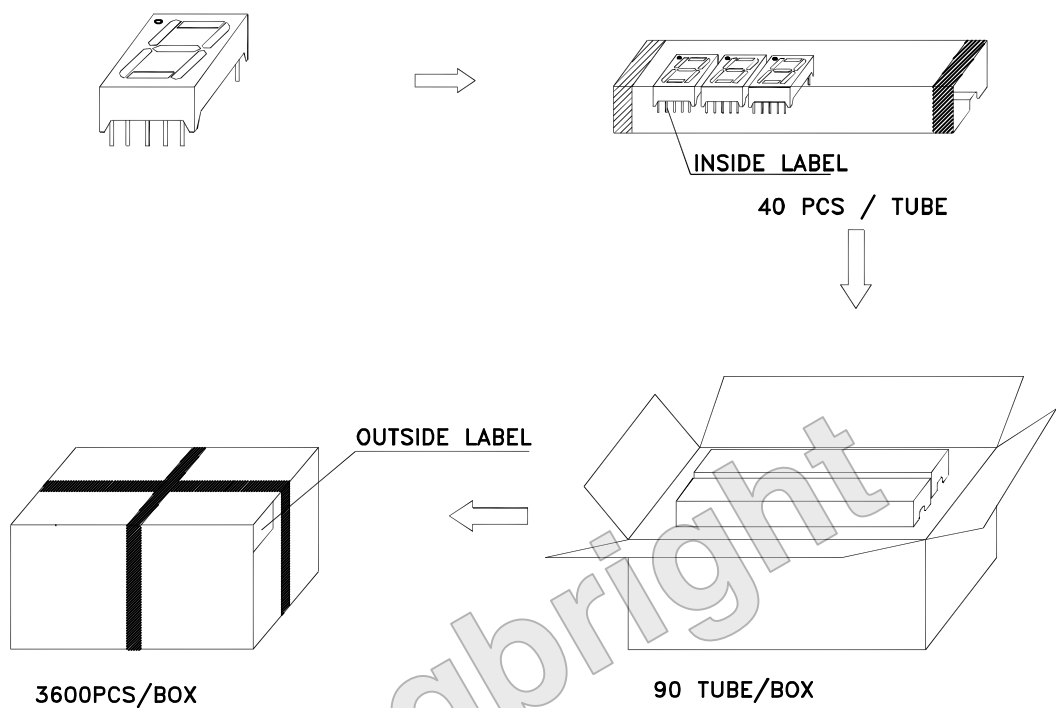
Hyper Red

SA56-11SURKWA

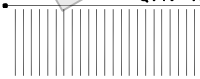



PACKING & LABEL SPECIFICATIONS



SA56-11SURKWA



Inside Label On IC-TUBE

| | | | |
|----------------------|------------------|---|---|
| Kingbright | TYPE: SX56-11XXX |  |  |
| QTY: 40 PCS CODE: xx | | | |
| RoHS Compliant | | Date | |
| LOT NO. | | Number OF FQC | |

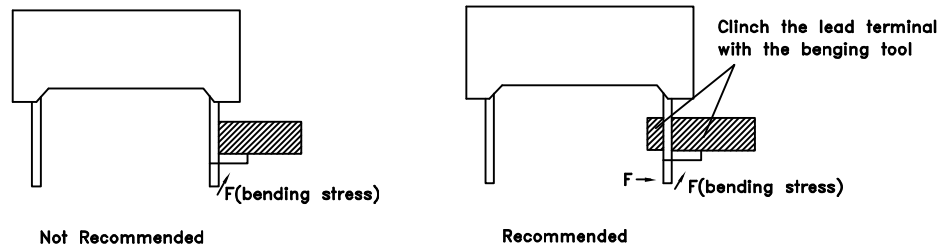
Outside Label On Box

| | | | |
|----------------|---|---|--------------|
| XXXXXX |  | Bin Code | Number OF QA |
| SX56-11XXX | | | |
| 3600 PCS | XX |  | Date |
| RoHS Compliant | | | |

THROUGH HOLE DISPLAY MOUNTING METHOD

Lead Forming

Do not bend the component leads by hand without proper tools.
The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

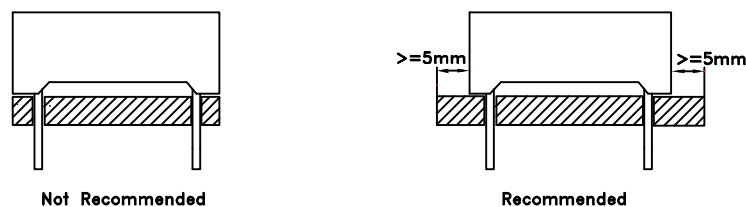


Installation

1. The installation process should not apply stress to the lead terminals.
2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

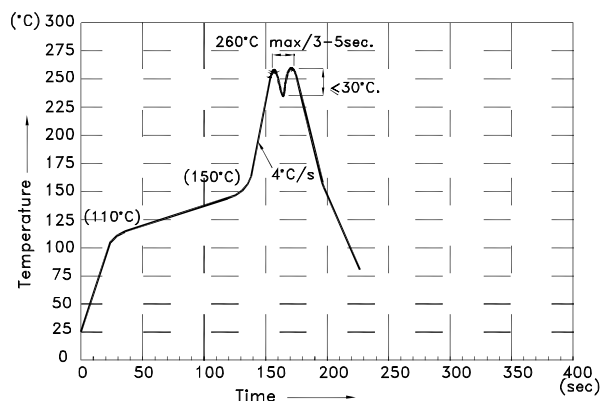


3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering, the PCB top-surface temperature should be kept below 105°C
5. No more than once.

Soldering General Notes:

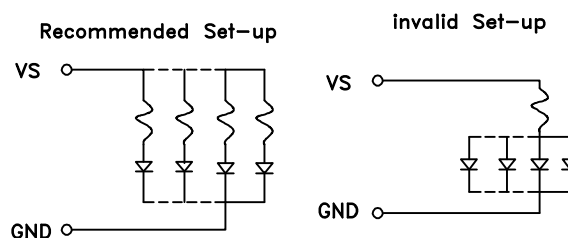
1. Through-hole displays are incompatible with reflow soldering.
2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts. And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



Detailed application notes are listed on our website.

http://www.kingbright.com/application_notes